imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

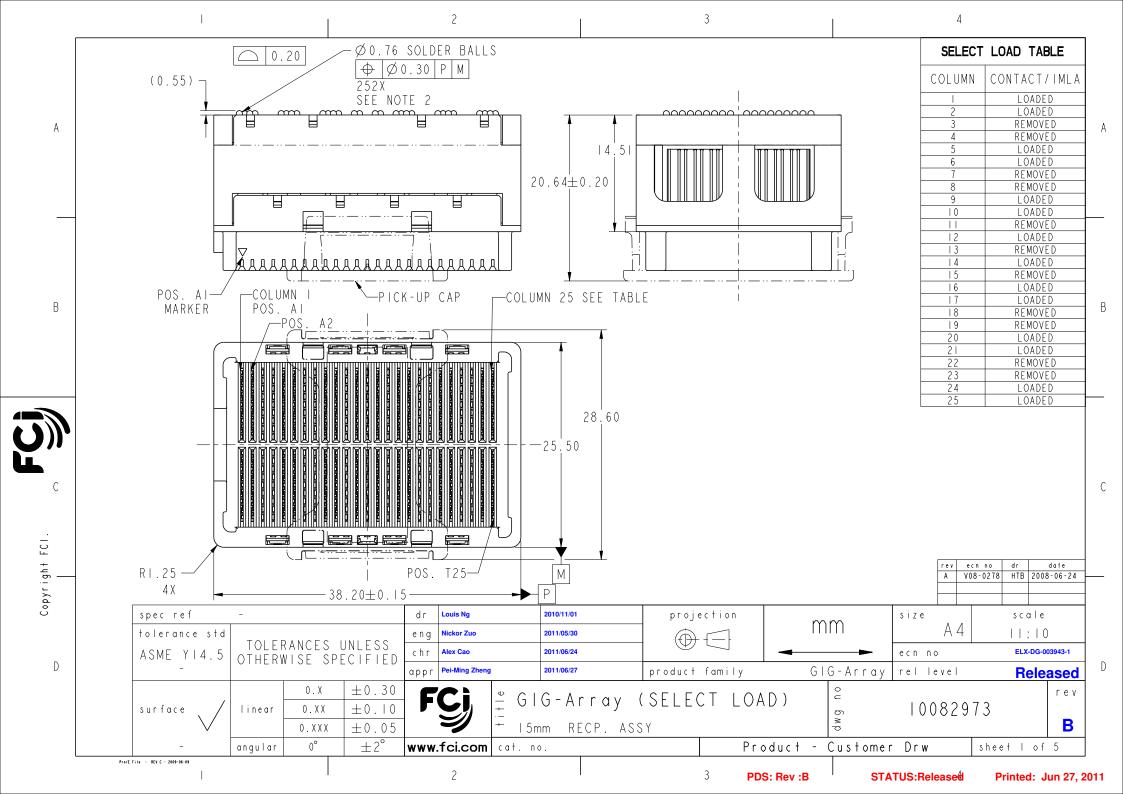
We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

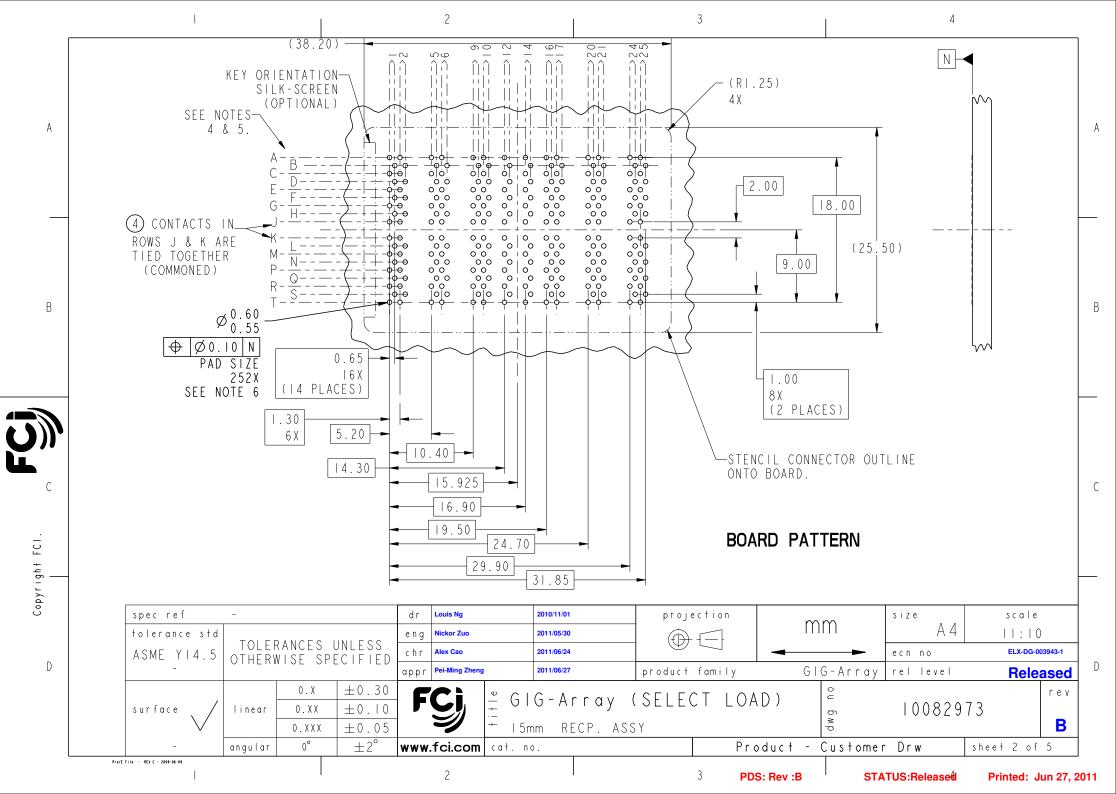


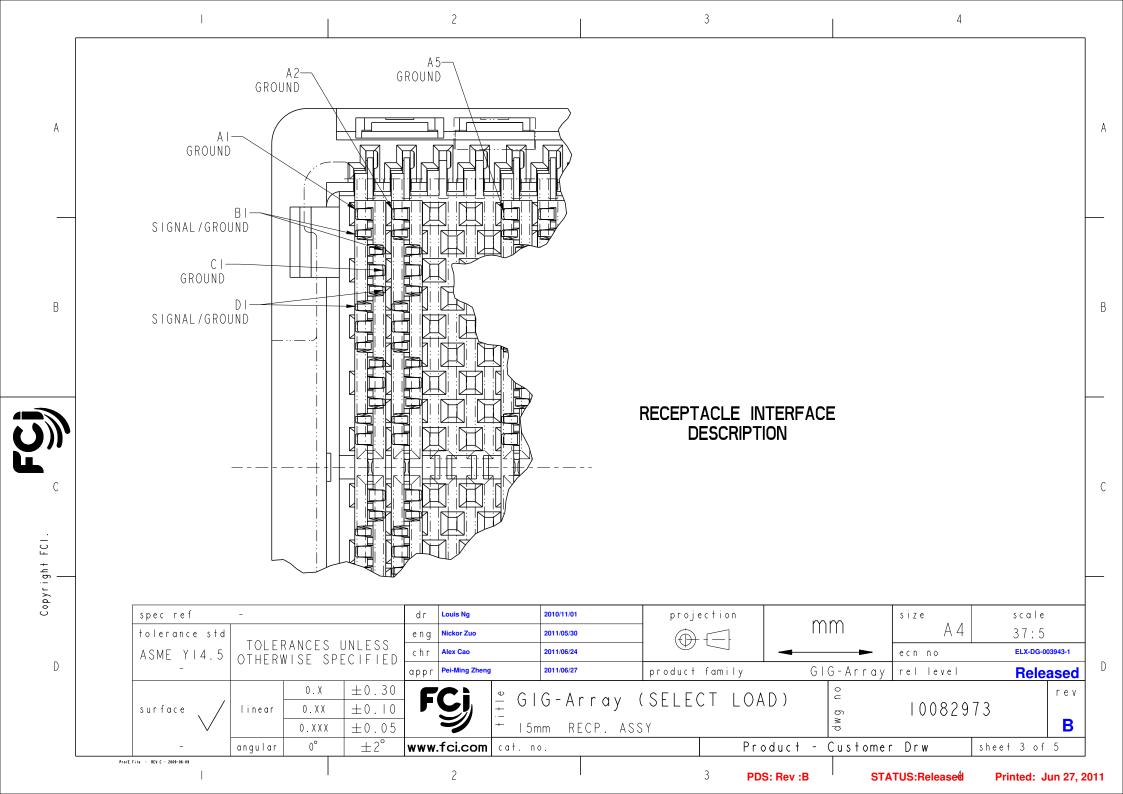
Contact us

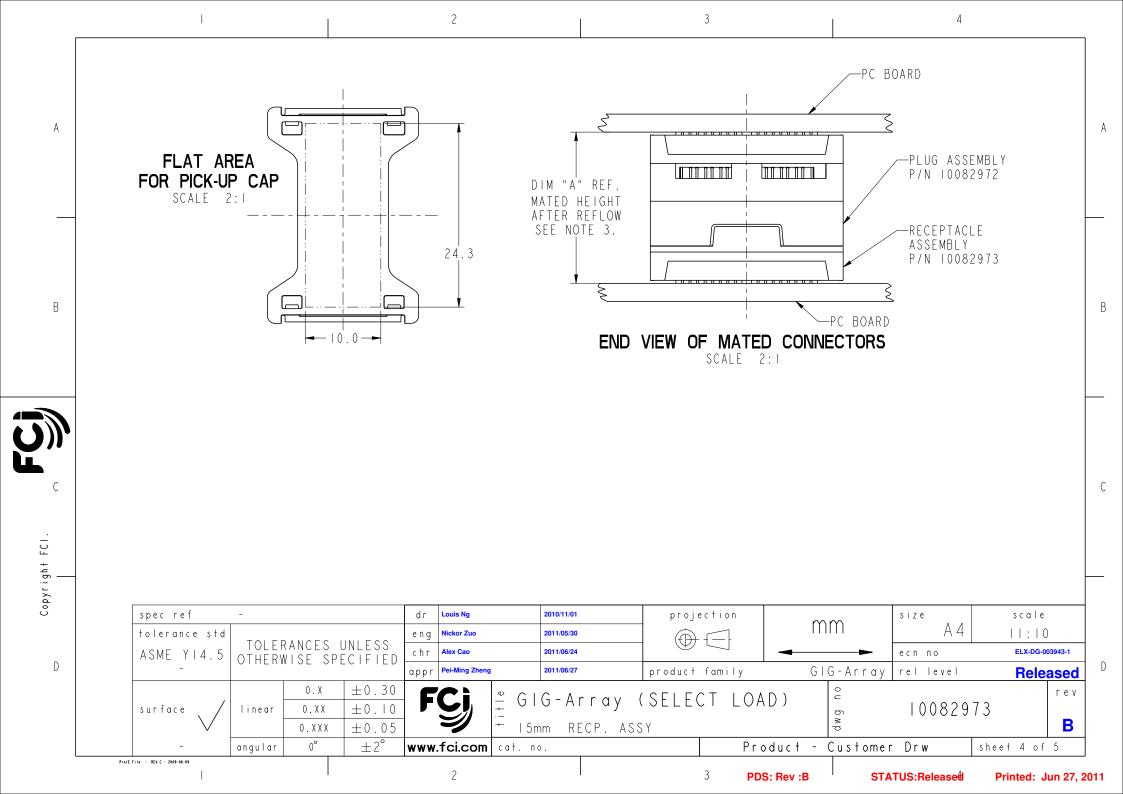
Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China











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	PRODUCT NUMBER	SOLDER BAL	L COMPOS	SITION		CONTA	CT PLA	TING PERFORMAN	CE LEVEL	L					
	10082973-001	STANDARD	(EUTEC	TIC)				PLATING,QUAL DF FCI PRODUCI			M				
	10082973-001LF	LEA	DFREE					NG TELCORDIA (N				
A		1		L											
	NOTES:														
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	UL RAT SOLDERI	ING: 94 V-O BALL: (SEE TABLI	E) EUTECTIC	2											
	_	R LEAD FREE 95.	5			(*) FOR PR	OPER APPLICATION F	OLLOW FCI A	APPLICATI	ON				
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	💛 PCB PAD S	GHT EFFECTED BY IZE, PLATING, SU SOLDER PASTE.	CUSTOMERS' DLDER REFLC	DW			PRODUC WITH L	A HIGHER REFLOW T T IS THEREFORE NOT EADED OR SOME SOLD NCE FCI APPLICATIO	BACKWARDS ERING APPLI	COMPATIB CATIONS.					
		IN ROWS A,C,E,G E BEAM CONTACTS		AND T }		(8	B.) THIS F	RODUCT MEETS THE E	JROPEAN UNI	ON DIREC	TIVES				
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		ED TOGETHER [CO		<u>^</u>				Y HAVING AN "X" IN							
	💛 ARE DUAL I	IN ROWS B,D,F,H BEAM CONTACTS, USED AS SIGNAL		2											
	6.) SPECIFIED	POSITIONAL TOL	ERANCE DEFI		PAD										
	TOLERANCE	WITHIN LAND PAT OF LAND PATTER S SHALL BE DEFI	N TO FUDICI	AL MARKS OR											
	FOR RECOM	MENDED PRODUCT . TAILS, SEE DOC.	APPLICATION	I AND PCB											
_															
	spec ref				dr	Louis Ng		2010/11/01	proje	ection			size	scal	e
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	ASME YI				chr	Alex Cao		2011/06/24			-		ecn no	ELX-DG	à-003943-1
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